NSN 5962-00-436-1461

Memory Microcircuit - Page 1 of 1

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Body Outside Diameter: 0.550 inches **Body Height:** Between 0.050 inches and 0.070 inches **Maximum Power Dissipation Rating:** 150.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and hermetically sealed and positive outputs **Inclosure Material:** Glass and metal **Inclosure Configuration:** Flat pack **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 4 input **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** 0.3 volts power source Memory Device Type: Rom **Precious Material And Location:** Terminal and body surfaces gold **Precious Material:** Gold **Test Data Document:** 13499-351-8063 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 34 flat leads

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

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